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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO	
10/667,605	09/23/2003	Bernd Karl Appelt	4459-130	9744	
75	90 12/14/2004		EXAM	EXAMINER	
LOWE HAUPTMAN GILMAN & BERNER, LLP			VU, QUANG D		
Suite 310 1700 Diagonal I	Road		ART UNIT	PAPER NUMBER	
Alexandria, VA			2811	· ·	
			DATE MAILED: 12/14/2004	4	

Please find below and/or attached an Office communication concerning this application or proceeding.

		_		- the				
		Application No.	Applicant(s)	•				
Office Action Summary		10/667,605	APPELT ET AL.					
		Examiner	Art Unit					
		Quang D Vu	2811					
<i>TI</i> Period for R	he MAILING DATE of this communication a eply	appears on the cover sheet with	1 the correspondence address					
THE MAI  - Extensions after SIX (  - If the period - If NO period - Failure to Any reply	TENED STATUTORY PERIOD FOR REF LING DATE OF THIS COMMUNICATION s of time may be available under the provisions of 37 CFR 6) MONTHS from the mailing date of this communication of do for reply specified above is less than thirty (30) days, a r od for reply is specified above, the maximum statutory perion reply within the set or extended period for reply will, by state received by the Office later than three months after the mattent term adjustment. See 37 CFR 1.704(b).	N. 1.136(a). In no event, however, may a repreply within the statutory minimum of thirty od will apply and will expire SIX (6) MONT tute, cause the application to become ABA	oly be timely filed  (30) days will be considered timely.  HS from the mailing date of this communication  NDONED (35 U.S.C. § 133).	1.				
Status								
1)⊠ Re	sponsive to communication(s) filed on <u>04</u>	October 2004.						
•		his action is non-final.						
3) Sin	3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is							
clo	sed in accordance with the practice unde	er Ex parte Quayle, 1935 C.D.	11, 453 O.G. 213.					
Disposition	of Claims							
4)⊠ Cla	nim(s) <u>1-5,10-15 and 20-24</u> is/are pending	g in the application.						
	Of the above claim(s) is/are withd			1				
5) ☐ Cla	Claim(s) is/are allowed.							
6)⊠ Cla								
7) Cla	Claim(s) is/are objected to.							
8)☐ Cla	nim(s) are subject to restriction and	d/or election requirement.						
Application	Papers							
9) <u></u> The	specification is objected to by the Exami	iner.						
10) <u></u> The	drawing(s) filed on is/are: a) a	ccepted or b) objected to b	y the Examiner.					
App	olicant may not request that any objection to the	he drawing(s) be held in abeyand	e. See 37 CFR 1.85(a).					
Rep	placement drawing sheet(s) including the corr	ection is required if the drawing(s	i) is objected to. See 37 CFR 1.121(c	<b>1</b> ).				
11) The	e oath or declaration is objected to by the	Examiner. Note the attached	Office Action or form PTO-152.					
Priority und	er 35 U.S.C. § 119							
a)	Certified copies of the priority docume	ents have been received. ents have been received in Ap riority documents have been r eau (PCT Rule 17.2(a)).	plication No eceived in this National Stage					
See	the attached detailed Office action for a li	ist of the certified copies not r	JUGIVEU.					
Attachment(s)	•			•				
	References Cited (PTO-892)	4) Interview Su						
3) 🔲 Informatio	Draftsperson's Patent Drawing Review (PTO-948) on Disclosure Statement(s) (PTO-1449 or PTO/SB/(s)/Mail Date	_	/Mail Date ormal Patent Application (PTO-152) 					

Application/Control Number: 10/667,605 Page 2

Art Unit: 2811

#### **DETAILED ACTION**

#### Election/Restrictions

Applicant's election with traverse of group I in the reply filed on 10/04/04 is acknowledged. The traversal is on the ground(s) that the restriction is not proper. This is not found persuasive because group II (claims 6-9 and 16-19) and group I (claims 1-5, 10-15 and 20-24) are related as product made and process of making, respectively. Additionally, the device of group I (claims 1-5, 10-15 and 20-24) invention could be made by as a materially different process. For example, partially encapsulating the chip and bonding wires up to the supporter, opening the window on the supporter corresponding to the optical element of the chip, and then completely encapsulating material to form a package body for fixing the window, instead of providing a supporter, disposing a window on the supporter, positioning the window corresponding to the optical element of the chip and then forming an encapsulant on the substrate for fixing the window and encapsulating the chip and the bonding wires.

The requirement is still deemed proper and is therefore made FINAL.

### Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Application/Control Number: 10/667,605 Page 3

Art Unit: 2811

2. Claims 1-5, 10-14 and 20-24 are rejected under 35 U.S.C. 102(b) as being anticipated by US Patent No. 4,732,042 to Adams.

Regarding claim 1, Adams (figures 1-2B) teaches an optical semiconductor package comprising:

a substrate (11);

a chip (pressure sensor chip [14]) having an optical element and disposed on the substrate (11);

a plurality of bonding wires (16) for electrically connecting the chip (14) to the substrate (11);

a window (15);

a supporter (a portion of [11b]) supporting the window (15) for positioning the window corresponding to the optical element of the chip (14); and

an encapsulant (19) formed on the substrate (11) for fixing the window (15) and encapsulating the chip (14) and the bonding wires (16).

Regarding claim 2, the claim limitations "the encapsulant is formed by means of the overmolding process" in claim 2 is taken to be product by process limitations, which does not carry weight in claim drawn to structure. A product by process claim directed to the product per se, no matter how actually made, In re Hirao, 190 USPQ 15 at 17 (footnote 3). See In re Fessman, 180 USPQ 324, 326 (CCPA 1974); In re Marosi et al., 218 USPQ 289, 292 (Fed. Cir. 1983); and particularly In re Thorpe, 227 USPQ 964, 966 (Fed. Cir. 1985), all of which make it clear that it is the patentability of the final structure of the product "gleaned" from the process steps, which must be determined in a "product by process" claim, and no the patentability of the

Application/Control Number: 10/667,605

Art Unit: 2811

process. See also MPEP 2113. Moreover, an old and obvious product produced by a new method is not a patentable product, whether claimed in "product by process" claims or not.

Regarding claim 3, Adams teaches paired snapping elements (notch [11d]) respectively disposed on the window (15) and the supporter (11b) for snapping the window with the supporter.

Regarding claim 4, Adams teaches the supporter (11b) further comprises a shoulder (a portion of the recess of [11b]) for supporting the window.

Regarding claim 5, Adams teaches the window is a lens (layer [18]).

Regarding claim 10, Adams (figures 1-2B) teaches an optical semiconductor package comprising:

a substrate (11);

a chip (pressure sensor chip [14]) having an optical element and disposed on the substrate (11);

a plurality of bonding wires (16) for electrically connecting the chip (14) to the substrate (11);

a window (15) mounted on the optical element of the chip (pressure sensor chip [14]); and an encapsulant (19) formed on the substrate (11) for fixing the window (15) and encapsulating the chip (14) and the bonding wires (16).

Regarding claim 11, the claim limitations "the encapsulant is formed by means of the overmolding process" in claim 11 is taken to be product by process limitations, which does not carry weight in claim drawn to structure. A product by process claim directed to the product per se, no matter how actually made, In re Hirao, 190 USPO 15 at 17 (footnote 3). See In re

Fessman, 180 USPQ 324, 326 (CCPA 1974); In re Marosi et al., 218 USPQ 289, 292 (Fed. Cir. 1983); and particularly In re Thorpe, 227 USPQ 964, 966 (Fed. Cir. 1985), all of which make it clear that it is the patentability of the final structure of the product "gleaned" from the process steps, which must be determined in a "product by process" claim, and no the patentability of the process. See also MPEP 2113. Moreover, an old and obvious product produced by a new method is not a patentable product, whether claimed in "product by process" claims or not.

Regarding claim 12, Adams teaches the window comprises a ledge (a portion of the recess of [11b]) for securing the window in the encapsulant.

Regarding claim 13, teaches the encapsulant (19) is made of an opaque material (column 3, line 40).

Regarding claim 14, Adams teaches the window is a lens (layer [18]).

Regarding claim 20, Adams (figures 1-2B) teaches an optical semiconductor package comprising:

a substrate (11);

a chip (pressure sensor chip [14]) having an optical element and disposed on the substrate (11);

a plurality of bonding wires (16) for electrically connecting the chip (14) to the substrate (11);

a window (15);

a supporter (a portion of [11b]) supporting the window (15) for positioning the window corresponding to the optical element of the chip (14); and

Application/Control Number: 10/667,605

Art Unit: 2811

an encapsulant (19) formed on the substrate (11) for hermetically fixing the supporter (a portion of [11b]) on the substrate (11).

Regarding claim 21, the claim limitations "the encapsulant is formed by means of the overmolding process" in claim 21 is taken to be product by process limitations, which does not carry weight in claim drawn to structure. A product by process claim directed to the product per se, no matter how actually made, In re Hirao, 190 USPQ 15 at 17 (footnote 3). See In re Fessman, 180 USPQ 324, 326 (CCPA 1974); In re Marosi et al., 218 USPQ 289, 292 (Fed. Cir. 1983); and particularly In re Thorpe, 227 USPQ 964, 966 (Fed. Cir. 1985), all of which make it clear that it is the patentability of the final structure of the product "gleaned" from the process steps, which must be determined in a "product by process" claim, and no the patentability of the process. See also MPEP 2113. Moreover, an old and obvious product produced by a new method is not a patentable product, whether claimed in "product by process" claims or not.

Regarding claim 22, Adams teaches the window (15) is hermetically disposed on the supporter (a portion of [11b]).

Regarding claim 23, Adams teaches the encapsulant (19) is made of an opaque material (column 3, line 40).

Regarding claim 24, Adams teaches the window is a lens (layer [18]).

## Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person

having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

4. Claim15 is rejected under 35 U.S.C. 103(a) as being unpatentable over US Patent No. 4,732,042 to Adams in view of US Patent No. 5,897,338 to Kaldenberg.

Regarding claim 15, Adams differs from the claimed invention by not showing an adhesive for mounting the window on the optical element of the chip. However, Kaldenberg (figure 4) teaches an adhesive (28) for mounting the window (26) on the chip (12). Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to incorporate the teaching of Kaldenberg into the device taught by Adams in order to hold the window in place.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Quang D Vu whose telephone number is 571-272-1667. The examiner can normally be reached on Monday-Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie Lee can be reached on 571-272-1732. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Page 8

Application/Control Number: 10/667,605

Art Unit: 2811

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

qv December 10, 2004

EDDIE LEE

SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2800